

# IRFL110PbF

HEXFET® Power MOSFET

- Surface Mount
- Available in Tape & Reel
- Dynamic dv/dt Rating
- Repetitive Avalanche Rated
- Fast Switching
- Ease of Paralleling
- Simple Drive Requirements
- Lead-Free

## Description

Third Generation HEXFETs from International Rectifier provide the designer with the best combination of fast switching, ruggedized device design, low on-resistance and cost-effectiveness.

The SOT-223 package is designed for surface-mount using vapor phase, infra red, or wave soldering techniques. Its unique package design allows for easy automatic pick-and-place as with other SOT or SOIC packages but has the added advantage of improved thermal performance due to an enlarged tab for heatsinking. Power dissipation of greater than 1.25W is possible in a typical surface mount application.

## Absolute Maximum Ratings

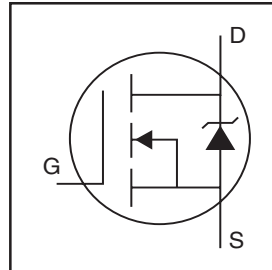
	Parameter	Max.	Units
$I_D$ @ $T_c = 25^\circ\text{C}$	Continuous Drain Current, $V_{GS}$ @ 10 V	1.5	A
$I_D$ @ $T_c = 100^\circ\text{C}$	Continuous Drain Current, $V_{GS}$ @ 10 V	0.96	
$I_{DM}$	Pulsed Drain Current ①	12	
$P_D$ @ $T_c = 25^\circ\text{C}$	Power Dissipation	3.1	W
$P_D$ @ $T_A = 25^\circ\text{C}$	Power Dissipation (PCB Mount)**	2.0	
	Linear Derating Factor	0.025	W/°C
	Linear Derating Factor (PCB Mount)**	0.017	
$V_{GS}$	Gate-to-Source Voltage	-/+20	V
$E_{AS}$	Single Pulse Avalanche Energy ②	150	mJ
$I_{AR}$	Avalanche Current ①	1.5	A
$E_{AR}$	Repetitive Avalanche Energy ①	0.31	mJ
dv/dt	Peak Diode Recovery dv/dt ③	5.5	V/ns
$T_J, T_{STG}$	Junction and Storage Temperature Range	-55 to + 150	°C
	Soldewring Temperature, for 10 seconds	300 (1.6mm from case)	

## Thermal Resistance

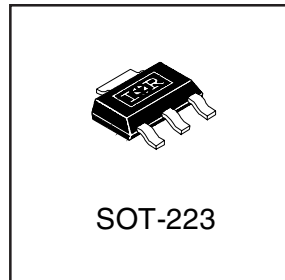
	Parameter	Typ.	Max.	Units
$R_{\theta JC}$	Junction-to-PCB	—	40	°C/W
$R_{\theta JA}$	Junction-to-Ambient. (PCB Mount)**	—	60	

\*\* When mounted on 1" square pcb (FR-4 or G-10 Material).

For recommended footprint and soldering techniques refer to application note #AN-994.



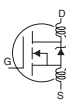
$V_{DSS} = 100V$
$R_{DS(on)} = 0.54\Omega$
$I_D = 1.5A$



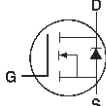
# IRFL110PbF

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 Rectifier

## Electrical Characteristics @ $T_J = 25^\circ\text{C}$ (unless otherwise specified)

	Parameter	Min.	Typ.	Max.	Units	Conditions
$V_{(BR)DSS}$	Drain-to-Source Breakdown Voltage	100	—	—	V	$V_{GS} = 0V, I_D = 250\mu A$
$\Delta V_{(BR)DSS}/\Delta T_J$	Breakdown Voltage Temp. Coefficient	—	0.63	—	V/°C	Reference to $25^\circ\text{C}, I_D = 1\text{mA}$
$R_{DS(on)}$	Static Drain-to-Source On-Resistance	—	—	0.54	$\Omega$	$V_{GS} = 10V, I_D = 0.90A$ ④
$V_{GS(th)}$	Gate Threshold Voltage	2.0	—	4.0	V	$V_{DS} = V_{GS}, I_D = 250\mu A$
$g_{fs}$	Forward Transconductance	1.1	—	—	S	$V_{DS} = 50V, I_D = 0.90A$ ④
$I_{DSS}$	Drain-to-Source Leakage Current	—	—	25	$\mu A$	$V_{DS} = 100V, V_{GS} = 0V$
		—	—	250		$V_{DS} = 80V, V_{GS} = 0V, T_J = 125^\circ\text{C}$
$I_{GSS}$	Gate-to-Source Forward Leakage	—	—	100	nA	$V_{GS} = 20V$
	Gate-to-Source Reverse Leakage	—	—	-100		$V_{GS} = -20V$
$Q_g$	Total Gate Charge	—	—	8.3	nC	$I_D = 5.6A$ $V_{DS} = 80V$ $V_{GS} = 10V$ , See Fig. 6 and 13 ④
$Q_{gs}$	Gate-to-Source Charge	—	—	2.3		
$Q_{gd}$	Gate-to-Drain ("Miller") Charge	—	—	3.8		
$t_{d(on)}$	Turn-On Delay Time	—	6.9	—	ns	$V_{DD} = 50V$ $I_D = 5.6A$ $R_G = 24\Omega$ $R_D = 8.4\Omega$ , See Fig. 10 ④
$t_r$	Rise Time	—	16	—		
$t_{d(off)}$	Turn-Off Delay Time	—	15	—		
$t_f$	Fall Time	—	9.4	—		
$L_D$	Internal Drain Inductance	—	4.0	—	nH	Between lead, 6mm(0.25in) from package and center of die contact. 
$L_S$	Internal Source Inductance	—	6.0	—		
$C_{iss}$	Input Capacitance	—	180	—	pF	$V_{GS} = 0V$ $V_{DS} = 25V$ $f = 1.0\text{MHz}$ , See Fig. 5
$C_{oss}$	Output Capacitance	—	81	—		
$C_{rss}$	Reverse Transfer Capacitance	—	15	—		

## Source-Drain Ratings and Characteristics

	Parameter	Min.	Typ.	Max.	Units	Conditions
$I_S$	Continuous Source Current (Body Diode)	—	—	1.5	A	MOSFET symbol showing the integral reverse p-n junction diode. 
$I_{SM}$	Pulsed Source Current (Body Diode) ①	—	—	12		
$V_{SD}$	Diode Forward Voltage	—	—	2.5	V	$T_J = 25^\circ\text{C}, I_S = 1.5A, V_{GS} = 0V$ ④
$t_{rr}$	Reverse Recovery Time	—	100	200	ns	$T_J = 25^\circ\text{C}, I_F = 5.6A$
$Q_{rr}$	Reverse Recovery Charge	—	0.44	0.88	$\mu C$	$di/dt = 100A/\mu s$ ④
$t_{on}$	Forward Turn-On Time	Intrinsic turn-on time is negligible (turn-on is dominated by $L_S+L_D$ )				

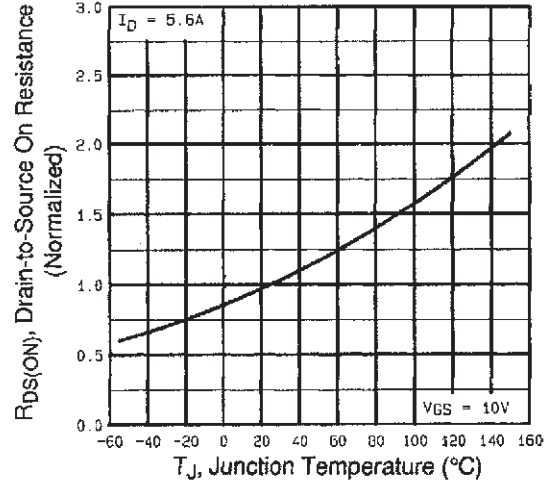
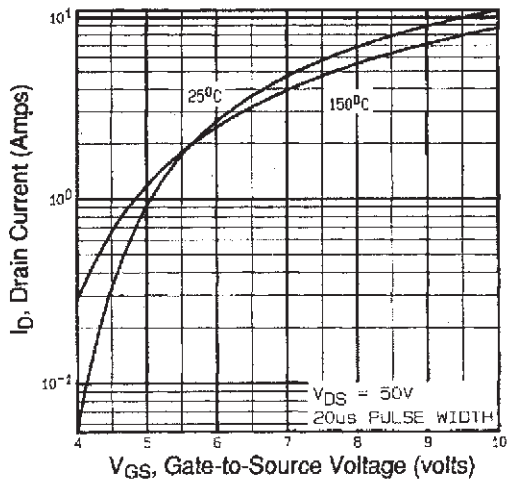
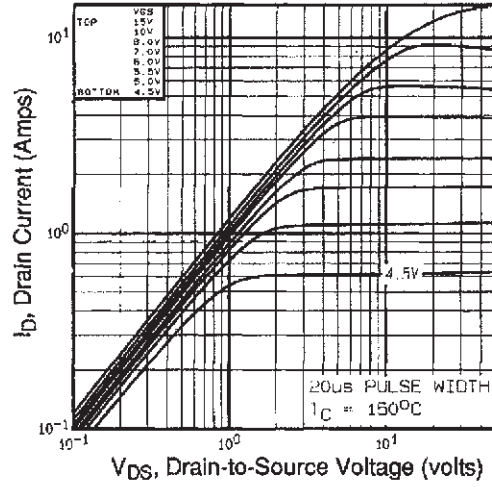
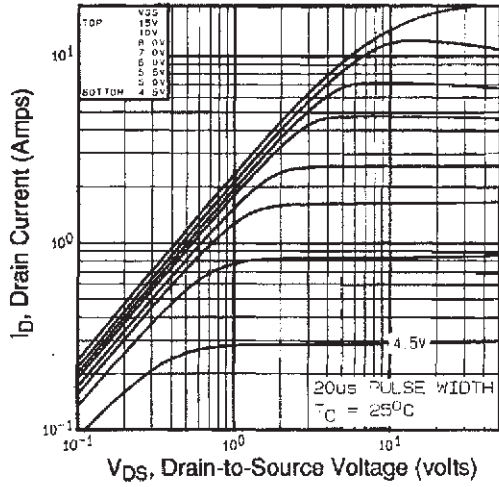
### Notes:

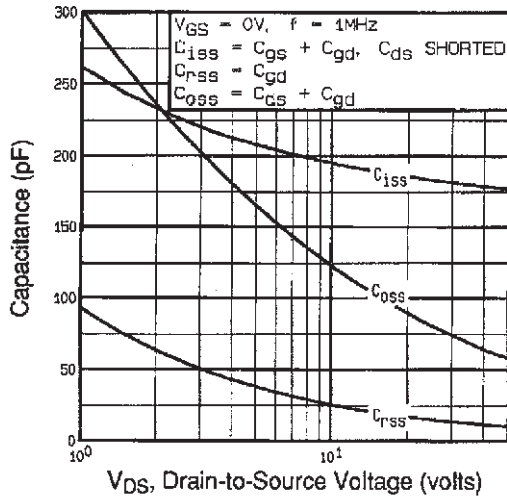
① Repetitive rating; pulse width limited by max. junction temperature. ( See fig. 11 )

②  $V_{DD}=25V$ , starting  $T_J = 25^\circ\text{C}$ ,  $L = 25\text{mH}$   
 $R_G = 25\Omega, I_{AS} = 3.0A$  (See Figure 12)

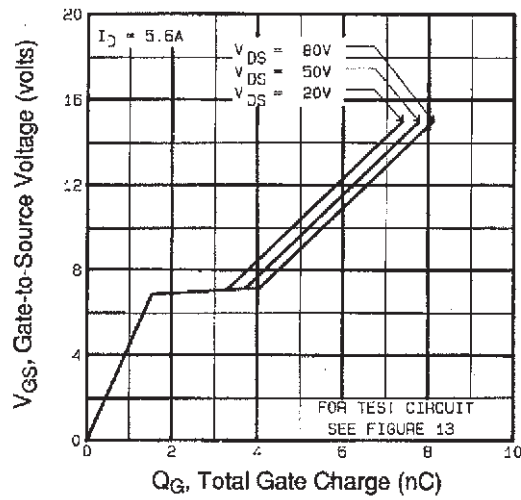
③  $I_{SD} \leq 5.6A, di/dt \leq 75A/\mu s, V_{DD} \leq V_{(BR)DSS}, T_J \leq 150^\circ\text{C}$

④ Pulse width  $\leq 300\mu s$ ; duty cycle  $\leq 2\%$ .

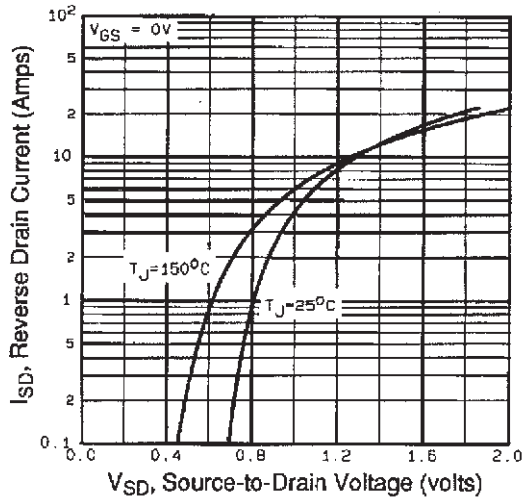




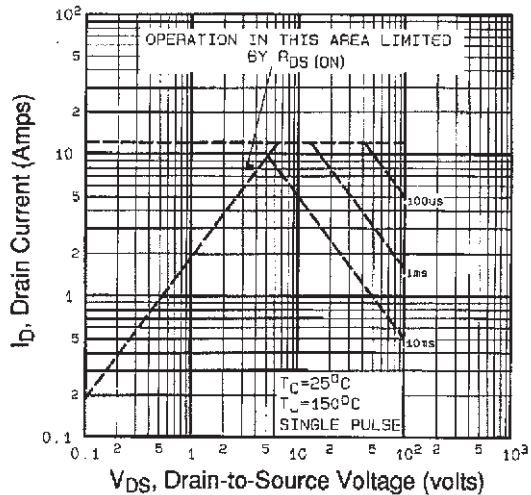
**Fig 5.** Typical Capacitance Vs. Drain-to-Source Voltage



**Fig 6.** Typical Gate Charge Vs. Gate-to-Source Voltage



**Fig 7.** Typical Source-Drain Diode Forward Voltage



**Fig 8.** Maximum Safe Operating Area

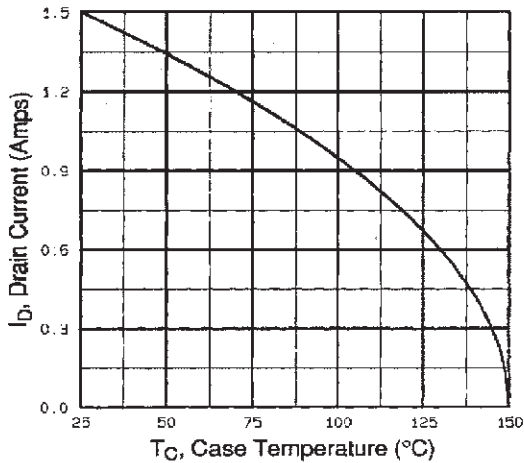


Fig 9. Maximum Drain Current Vs. Case Temperature

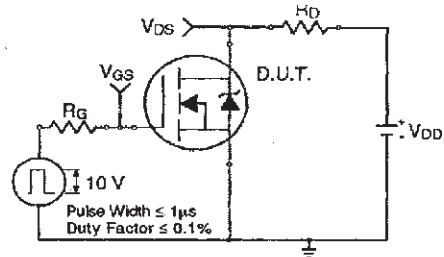


Fig 10a. Switching Time Test Circuit

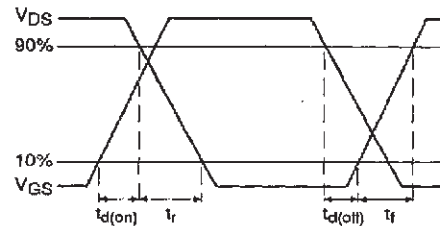


Fig 10b. Switching Time Waveforms

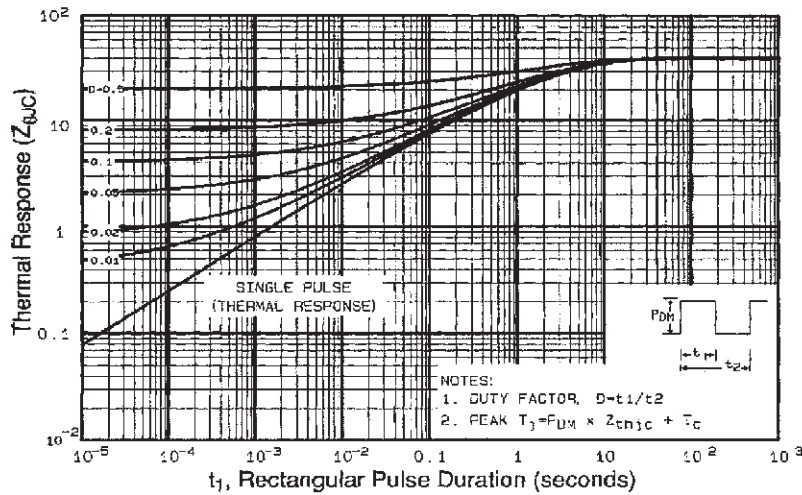


Fig 11. Maximum Effective Transient Thermal Impedance, Junction-to-Case

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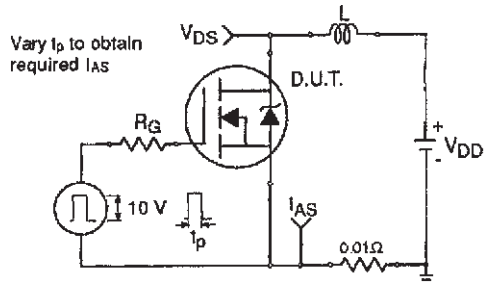


Fig 12a. Unclamped Inductive Test Circuit

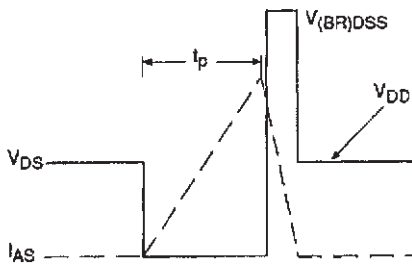


Fig 12b. Unclamped Inductive Waveforms

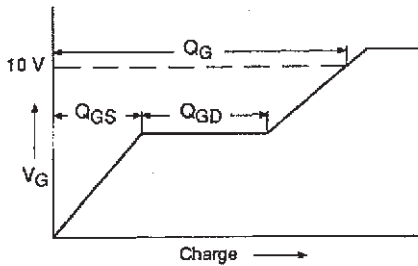


Fig 13a. Basic Gate Charge Waveform

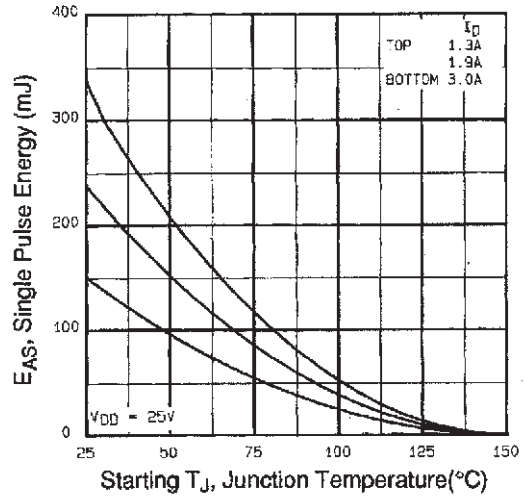


Fig 12c. Maximum Avalanche Energy Vs. Drain Current

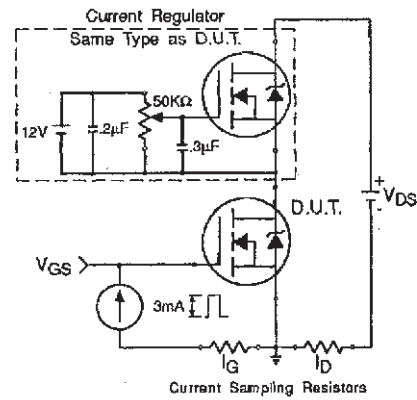
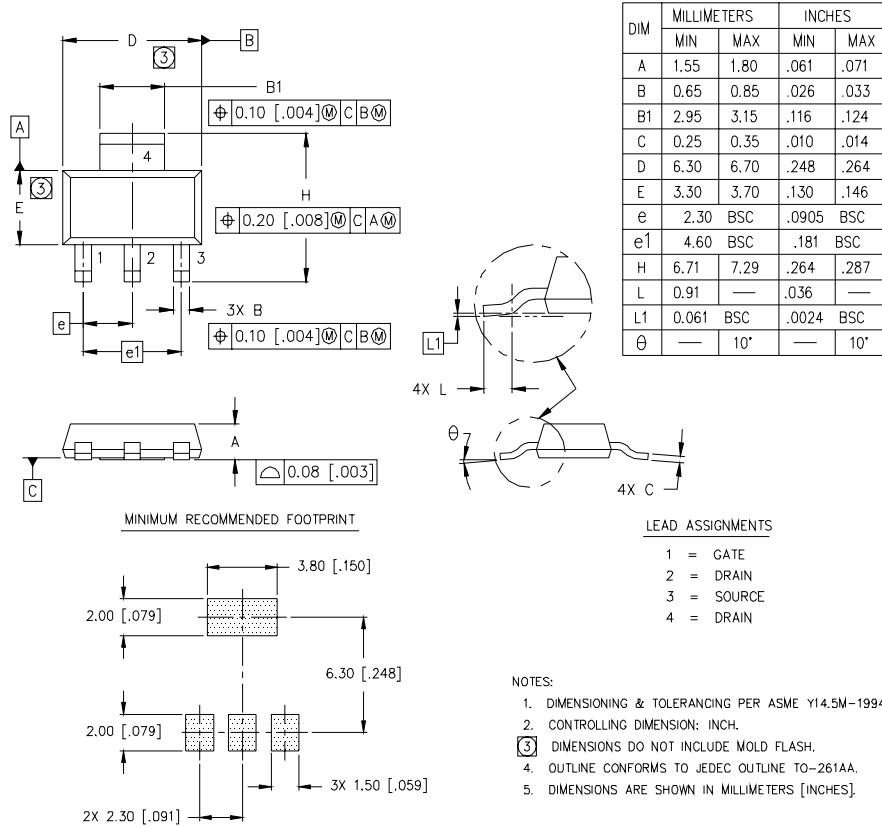


Fig 13b. Gate Charge Test Circuit

## SOT-223 (TO-261AA) Package Outline

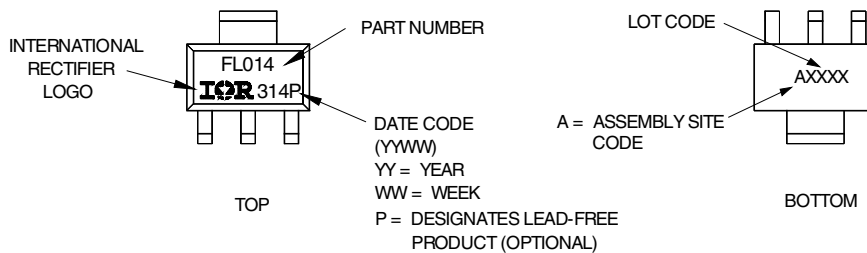
Dimensions are shown in millimeters (inches)



## SOT-223 (TO-261AA) Part Marking Information

### HEXFET PRODUCT MARKING

EXAMPLE: THIS IS AN IRFL014

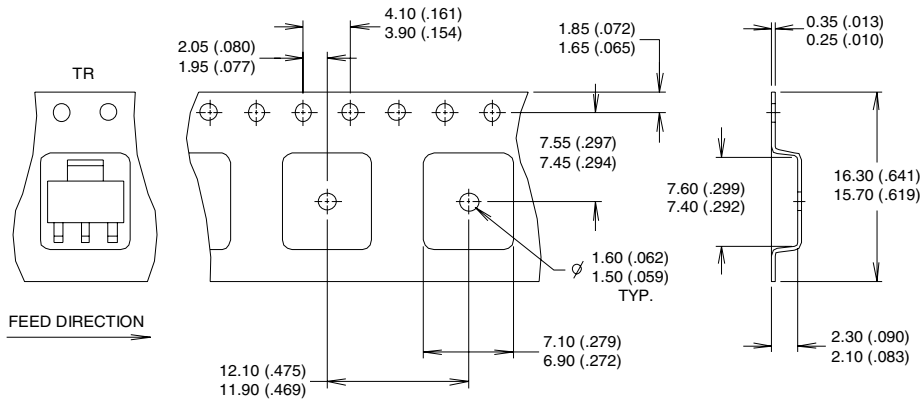


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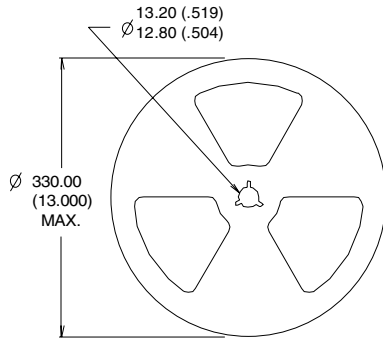
## SOT-223 (TO-261AA) Tape & Reel Information

Dimensions are shown in millimeters (inches)



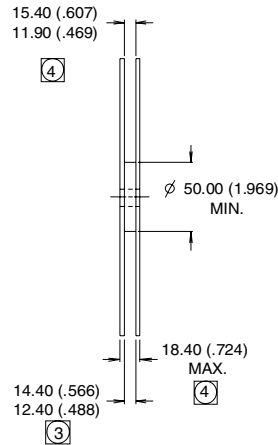
**NOTES :**

1. CONTROLLING DIMENSION: MILLIMETER.
2. OUTLINE CONFORMS TO EIA-481 & EIA-541.
3. EACH  $\varnothing 330.00$  (13.00) REEL CONTAINS 2,500 DEVICES.



**NOTES :**

1. OUTLINE CONFORMS TO EIA-418-1.
2. CONTROLLING DIMENSION: MILLIMETER.
- ③ DIMENSION MEASURED @ HUB.
- ④ INCLUDES FLANGE DISTORTION @ OUTER EDGE.



Data and specifications subject to change without notice.

International  
**IR** Rectifier

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05/04





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